

FEATURES

- Wide Operating Temperature Range
- Excellent Bond And Adhesion Strength
- Excellent Thermal Conductivity
- Additional Activator
- Fast And Secure Curing Rate

RS PRO Acrylic Thermal Adhesive, 5 → 10 min Cure, 0.82W/mK, 20 ml Syringe

RS Stock No.: 725-9993



RS Professionally Approved Products bring to you professional quality parts across all product categories. Our product range has been tested by engineers and provides a comparable quality to the leading brands without paying a premium price.



Product Description

Introducing the heat sink adhesive with activator from our trusted and reliable own brand RS PRO, a bonding kit perfect for the thermal coupling of electrical and electronic components, or between any surface where thermal conductivity or heat dissipation is vital. This RS PRO thermally conductive kit features an acrylic resin that flows under pressure to produce a strong bond with excellent heat dissipation, with an additional activator used to speed up the reaction. This versatile kit offers a wide operating temperature range of -50°C to +150°C and is perfect as a replacement for adhesive tapes, mechanical clips and epoxies.

General Specifications

Туре	Thermal Conductive Adhesive
Product Material	Acrylic
Physical Form	Liquid
Package Type	Syringe
Package Size	20ml
Thermal Conductivity	0.82W/mK
Cure Time	5min to 10min
Colour	White
Density @ 20°C	1.36g/cm3
Chemical Composition	Heptane, Methyl cyclohexane, Propan-1-ol, Pyridine
Odour	Hydrocarbons
Minimum Operating Temperature	-50°C
Maximum Operating Temperature	150°C
Operating Temperature Range	50°C to 150°C
Special Features	Excellent Thermal Conductivity
Application	Heat sink bonding, Potting/encapsulating sensors, BGA die heat spreader interface, Chip scale packages, Power semiconductors

Mechanical Specifications

Viscosity Measurement	500,000mPaS



Approvals

Compliance/Certifications 2011/65/EU and 2015/863

